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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10090094	FILING DATE 03/04/2002	CLASS 257	SUBCLASS 111	GAU 2827 2611	EXAMINER LUAN THAI
**APPLICANTS: Cheng Man Hon; Chow Wai; Keung Ho Wai.					
**CONTINUING DATA VERIFIED: (None) LT					
** FOREIGN APPLICATIONS VERIFIED: (None) LT					
PG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiners's initials		<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no LT		ATTORNEY DOCKET NO SC11352HP	
TITLE : Method of attaching a die to a substrate					

U.S. DEPT. OF COMM. PAT. & TM. PTO-436 (Rev. 1/04)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner	DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner	
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